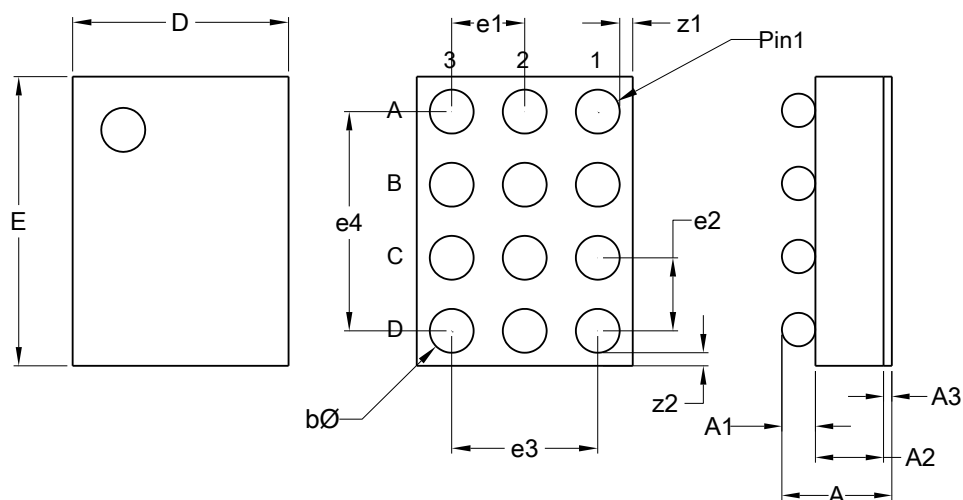


Package Outline Dimensions

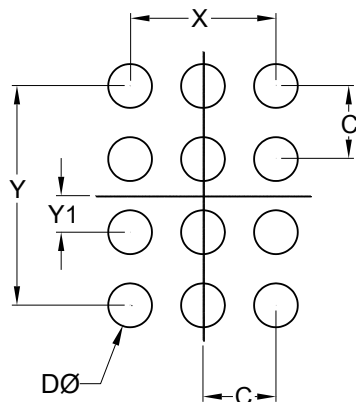
U-WLB1014-12 (Type JC)



U-WLB1014-12 (Type JC)			
Dim	Min	Max	Typ
A	0.489	0.565	0.527
A1	0.140	0.180	0.160
A2	0.313	0.339	0.326
A3	0.035	0.045	0.040
b	0.191	0.231	0.211
D	1.020	1.050	1.035
E	1.370	1.400	1.385
e1	--	--	0.350
e2	--	--	0.350
e3	--	--	0.700
e4	--	--	1.050
z1	--	--	0.063
z2	--	--	0.063
All Dimensions in mm			

Suggested Pad Layout

U-WLB1014-12 (Type JC)



Dimensions	Value (in mm)
C	0.350
D	0.211
X	0.700
Y	1.050
Y1	0.175

ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.